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May 2016



FDMS6673BZ

# P-Channel PowerTrench<sup>®</sup> MOSFET -30 V, -82 A, 6.8 m $\Omega$

#### **Features**

- Max  $r_{DS(on)}$  = 6.8 m $\Omega$  at  $V_{GS}$  = -10 V,  $I_D$  = -15.2 A
- Max  $r_{DS(on)}$  = 12.5 m $\Omega$  at  $V_{GS}$  = -4.5 V,  $I_D$  = -11.2 A
- Advanced Package and Silicon Combination for Low r<sub>DS(on)</sub>
- HBM ESD Protection Level of 8 kV Typical(Note 3)
- MSL1 Robust Package Design
- RoHS Compliant

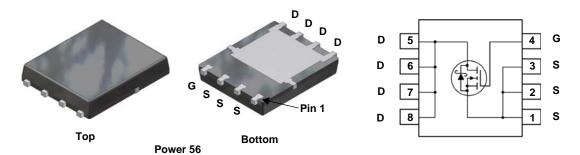


#### **General Description**

The FDMS6673BZ has been designed to minimize losses in load switch applications. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{\text{DS}(\text{on})}$  and ESD protection.

#### **Applications**

- Load Switch in Notebook and Server
- Notebook Battery Pack Power Management



## **MOSFET Maximum Ratings** $T_C = 25$ °C unless otherwise noted.

Symbol	Parameter			Ratings	Units
$V_{DS}$	Drain to Source Voltage			-30	V
V <sub>GS</sub>	Gate to Source Voltage			±25	V
I <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	-82	
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	-52	A
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	-15.2	7 ^
	-Pulsed		(Note 4)	-422	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		73	W
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	\ \v
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature	Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS6673BZ	FDMS6673BZ	Power 56	13 "	12 mm	3000 units

## **Electrical Characteristics** $T_J$ = 25 °C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	Off Characteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = -250 μA, V <sub>GS</sub> = 0 V	-30			V	
$\frac{\Delta BV_{DS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 $\mu$ A, referenced to 25 °C		-18		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -24 V, V <sub>GS</sub> = 0 V			-1	μА	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μА	

#### On Characteristics

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1.0	-1.8	-3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> = -250 μA, referenced to 25 °C		7		mV/°C
		$V_{GS} = -10 \text{ V}, I_D = -15.2 \text{ A}$		5.2	6.8	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -11.2 \text{ A}$		7.8	12.5	mΩ
, ,		$V_{GS} = -10 \text{ V}, I_D = -15.2 \text{ A}, T_J = 125 ^{\circ}\text{C}$		7.5	9.8	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -5 V, I <sub>D</sub> = -15.2 A		76		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	4444	5915	pF
C <sub>oss</sub>	Output Capacitance		781	1040	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		695	1045	pF
$R_g$	Gate Resistance		4.5		Ω

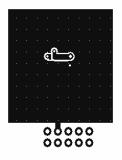
#### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		$V_{DD}$ = -15 V, $I_{D}$ = -15.2 A, $V_{GS}$ = -10 V, $R_{GEN}$ = 6 $\Omega$		14	26	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -15 V, I <sub>D</sub> = -15			28	45	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = -10 V, R <sub>GEN</sub> =			97	156	ns
t <sub>f</sub>	Fall Time				79	127	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to -10 V			93	130	nC
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to -5 V			52	73	nC
Q <sub>gs</sub>	Gate to Source Charge		I <sub>D</sub> = -15.2 A		13		nC
$Q_{gd}$	Gate to Drain "Miller" Charge				26		nC

#### **Drain-Source Diode Characteristics**

V	Con Source to Drain Diode, Forward Voltage	$V_{GS} = 0 \text{ V, } I_S = -2.1 \text{ A}$ (Note 2)	0.7	1.20	V
V <sub>SD</sub>		$V_{GS} = 0 \text{ V}, I_S = -15.2 \text{ A}$ (Note 2)	0.8	1.25	
t <sub>rr</sub>	Reverse Recovery Time	L = 15.2 A di/dt = 100 A/va	33	53	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = -15.2 A, di/dt = 100 A/μs	20	32	nC

The R<sub>θ,JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>θ,JC</sub> is guaranteed by design while R<sub>θCA</sub> is determined by the user's board design.



a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

- Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.</li>
   The diode connected between the gate and source servers only as protection against ESD. No gate overvoltage rating is implied.
   Pulsed Id please refer to Fig 11 SOA graph for more details.
   Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal relectro-mechanical application board design.

## **Typical Characteristics** T<sub>J</sub> = 25 °C unless otherwise noted.

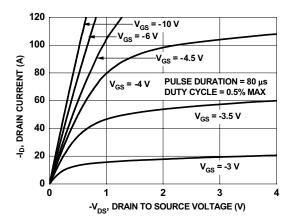


Figure 1. On Region Characteristics

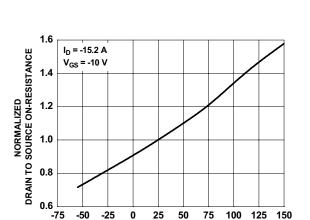


Figure 3. Normalized On Resistance vs. Junction Temperature

T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

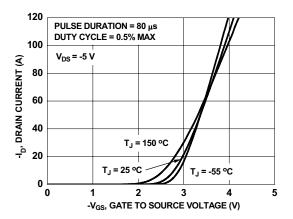


Figure 5. Transfer Characteristics

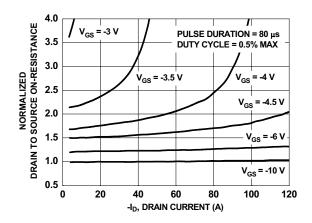


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

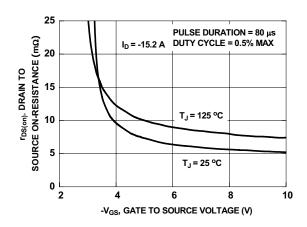


Figure 4. On-Resistance vs. Gate to Source Voltage

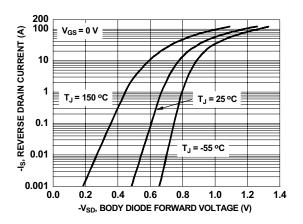


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

### **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

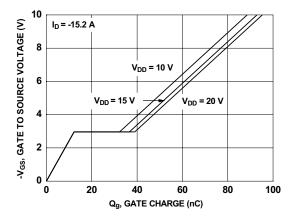


Figure 7. Gate Charge Characteristics

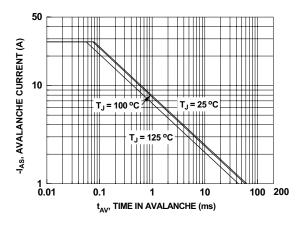


Figure 9. Unclamped Inductive Switching Capability

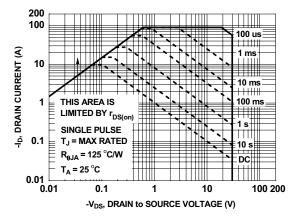


Figure 11. Forward Bias Safe Operating Area

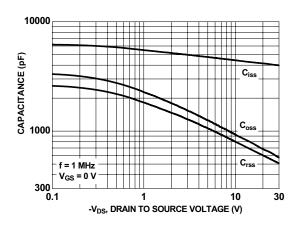


Figure 8. Capacitance vs. Drain to Source Voltage

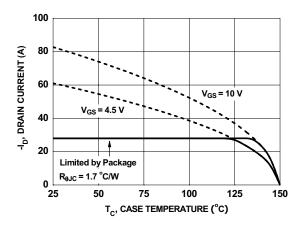


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

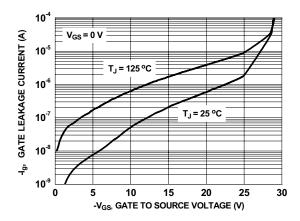


Figure 12. Igss vs. Vgss

### **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

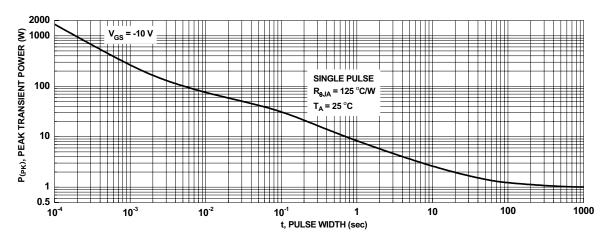


Figure 13. Single Pulse Maximum Power Dissipation

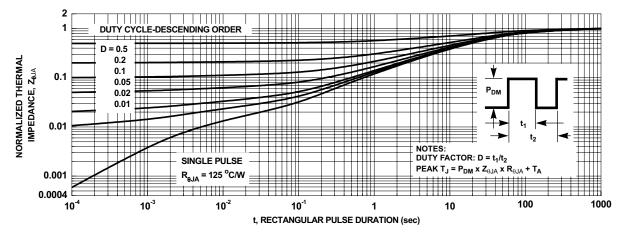
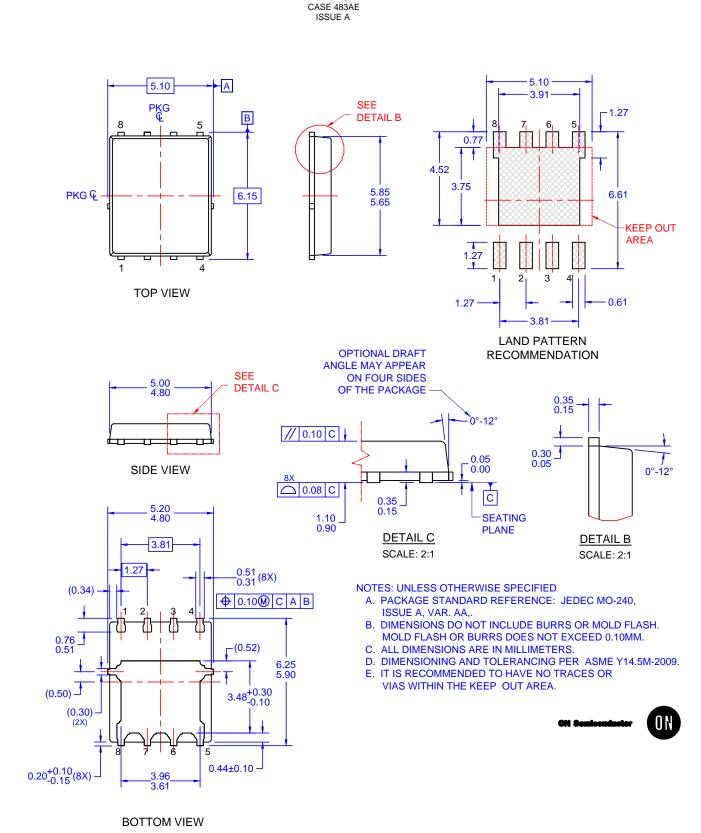


Figure 14. Junction-to-Case Transient Thermal Response Curve



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